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Kind regards,

Team Nexperia



Dual N-channel $\mu\text{TrenchMOS}$ standard level FET

Rev. 02 — 19 April 2010

Product data sheet

1. Product profile

1.1 General description

Dual N-channel enhancement mode field-effect transistor in a small SOT363 (SC-88) Surface-Mounted Device (SMD) plastic package using TrenchMOS technology.

1.2 Features and benefits

- Surface-mounted package
- Standard level threshold voltage
- Low on-state resistance

1.3 Applications

Driver circuits

1.4 Quick reference data

- $V_{DS} \le 60 V$
- $P_{tot} \le 0.41 \text{ W}$

- Footprint 40 % smaller than SOT23
- Fast switching
- Dual device
- Switching in portable appliances
- I_D \leq 0.49 A
- $\blacksquare \quad R_{DSon} \le 920 \ m\Omega$

2. Pinning information

	-	C-88), simplified outline and sym	
Pin	Description	Simplified outline	Graphic symbol
1	source1 (S1)		
2	gate1 (G1)		D ₁ D ₂
3	drain2 (D2)		
4	source2 (S2)		
5	gate2 (G2)	1 2 3	
6	drain1 (D1)	SOT363 (SC-88)	$S_1 G_1 S_2 G_2$
			msd901



Dual N-channel µTrenchMOS standard level FET

3. Ordering information

Table 2. Ordering information					
Type number	Package	je			
	Name	Description	Version		
PMGD780SN	SC-88	plastic surface-mounted package; 6 leads	SOT363		

4. Limiting values

Table 3. Limiting values

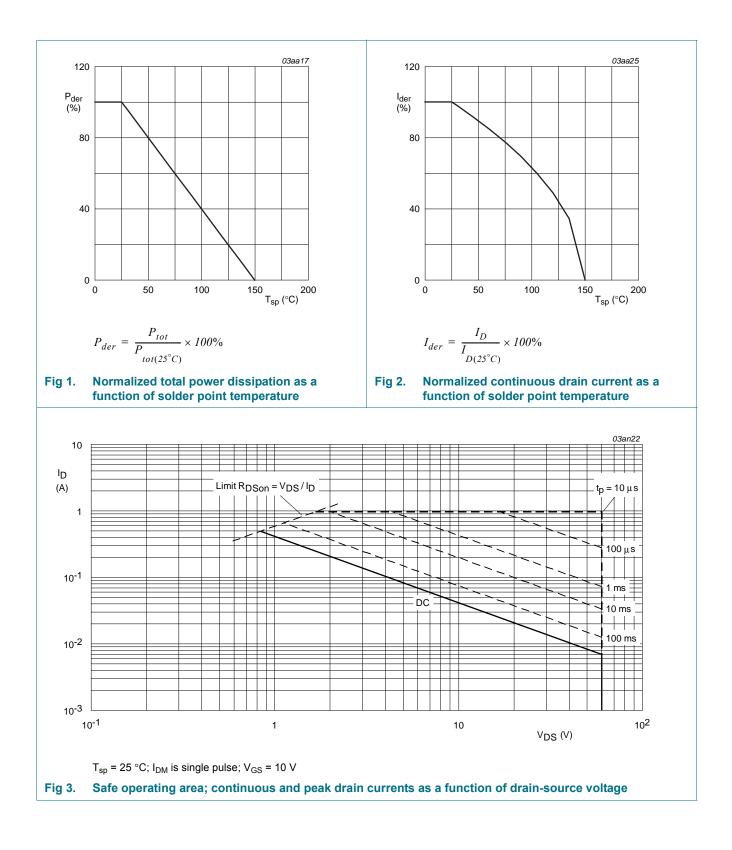
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	$25~^{\circ}C \leq T_{j} \leq 150~^{\circ}C$	-	60	V
V_{DGR}	drain-gate voltage	25 °C \leq T_{j} \leq 150 °C; R_{GS} = 20 $k\Omega$	-	60	V
V_{GS}	gate-source voltage		-	±20	V
I _D	drain current	T_{sp} = 25 °C; V_{GS} = 10 V; <u>Figure 2</u> and <u>3</u>	<u>[1]</u> _	0.49	А
		T _{sp} = 100 °C; V _{GS} = 10 V; <u>Figure 2</u>	<u>[1]</u> _	0.31	А
I _{DM}	peak drain current	T_{sp} = 25 °C; pulsed; $t_p \leq$ 10 $\mu s;$ Figure 3	<u>[1]</u> _	0.99	А
P _{tot}	total power dissipation	T _{sp} = 25 °C; <u>Figure 1</u>	-	0.41	W
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+150	°C
Source-o	drain diode				
I _S	source current	T _{sp} = 25 °C	<u>[1]</u> _	0.34	А
I _{SM}	peak source current	T_{sp} = 25 °C; pulsed; $t_p \leq$ 10 μs	<u>[1]</u> _	0.69	А

[1] Single device conducting.

PMGD780SN

Dual N-channel μ TrenchMOS standard level FET

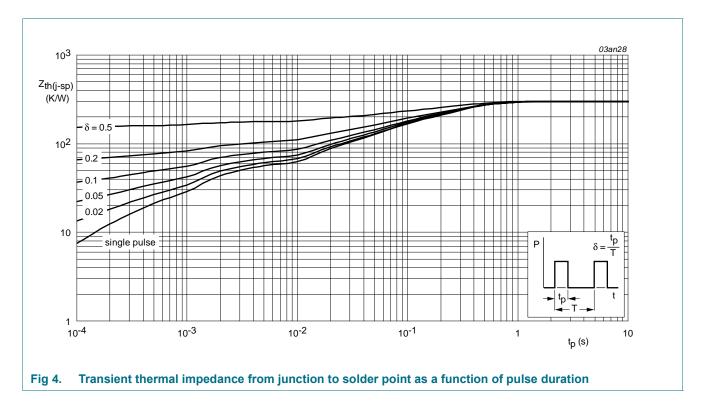


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5. Thermal characteristics

Table 4.Thermal characteristics





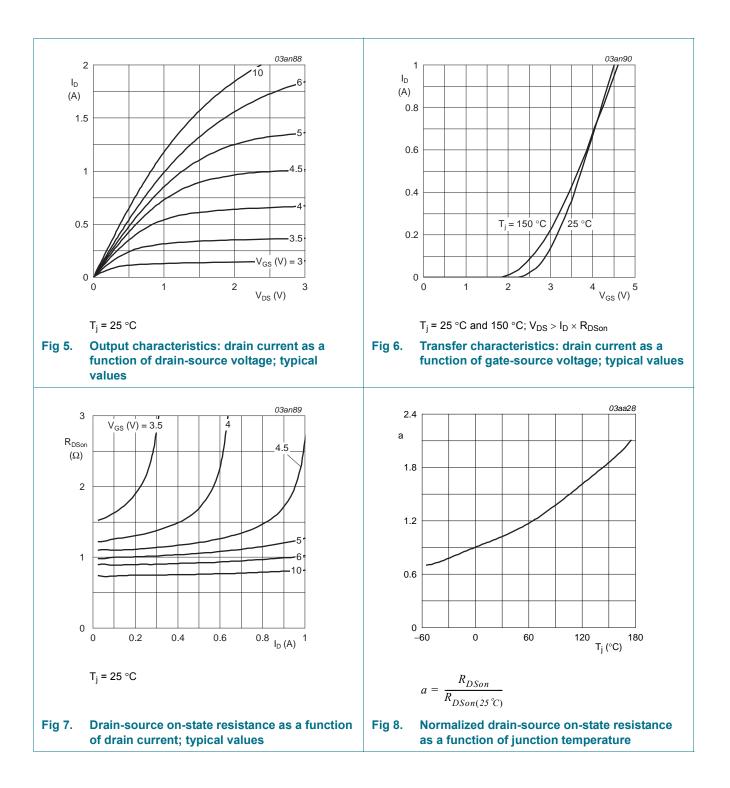
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6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static ch	aracteristics					
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V				
		T _j = 25 °C	60	-	-	V
		T _j = −55 °C	55	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 0.25 mA; V _{DS} = V _{GS} ; <u>Figure 9</u>				
		T _j = 25 °C	1	2	2.5	V
		T _j = 150 °C	0.6	_	-	V
		T _j = −55 °C	_	_	3.5	V
I _{DSS}	drain leakage current	V _{DS} = 60 V; V _{GS} = 0 V				
		T _j = 25 °C	-	0.05	1	μA
		T _j = 150 °C	-	-	100	μA
I _{GSS}	gate leakage current	V_{GS} = ±20 V; V_{DS} = 0 V	-	10	100	nA
R_{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I _D = 0.3 A; <u>Figure 7</u> and <u>8</u>				
		T _j = 25 °C	-	780	920	mΩ
		T _j = 150 °C	-	1445	1700	mΩ
		V_{GS} = 4.5 V; I_{D} = 0.075 A; Figure 7 and 8	-	1100	1400	mΩ
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	I_D = 1 A; V_{DD} = 30 V; V_{GS} = 10 V; <u>Figure 13</u>	-	1.05	-	nC
Q _{GS}	gate-source charge			0.2	-	nC
Q_{GD}	gate-drain charge		-	0.22	-	nC
C _{iss}	input capacitance	V _{GS} = 0 V; V _{DS} = 30 V; f = 1 MHz; <u>Figure 11</u>	-	23	-	pF
C _{oss}	output capacitance			5	-	pF
C _{rss}	reverse transfer capacitance		-	3.5	-	pF
t _{d(on)}	turn-on delay time	V_{DD} = 30 V; R_{L} = 30 $\Omega;$ V_{GS} = 10 V; R_{G} = 6 Ω	-	2	-	ns
t _r	rise time		-	4	-	ns
t _{d(off)}	turn-off delay time		-	5	-	ns
t _f	fall time		-	2.2	-	ns
Source-	drain diode					
V _{SD}	source-drain voltage	I _S = 0.3 A; V _{GS} = 0 V; Figure 12	-	0.83	1.2	V

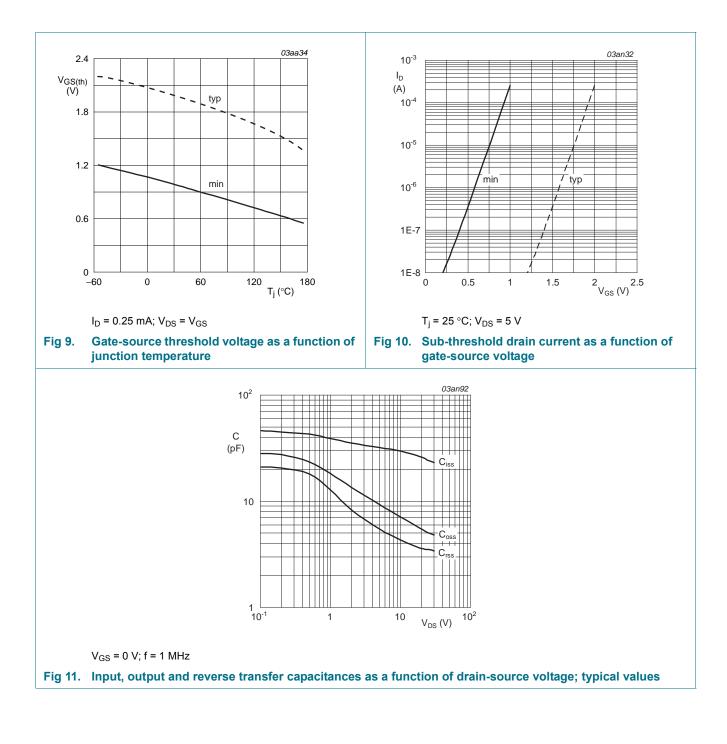
PMGD780SN

Dual N-channel μ TrenchMOS standard level FET



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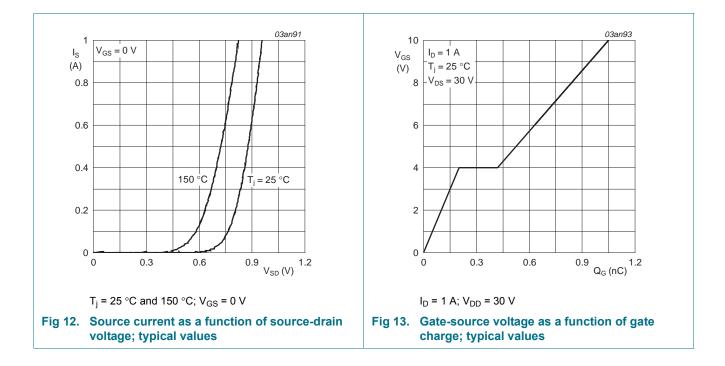
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PMGD780SN

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7. Package outline

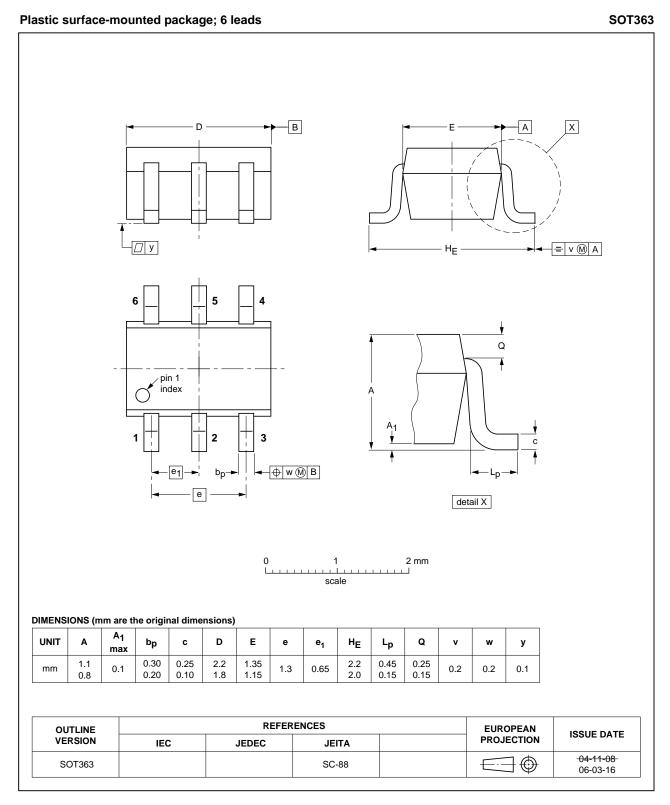


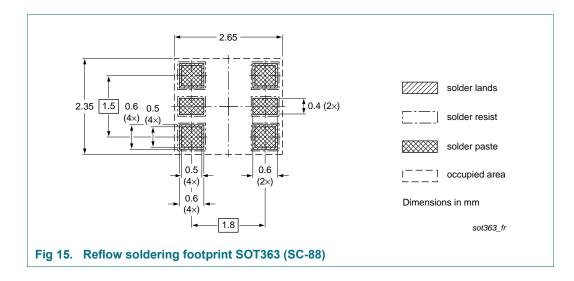
Fig 14. Package outline SOT363 (SC-88)

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PMGD780SN_2

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8. Soldering



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9. Revision history

Table 6. Revision I	history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMGD780SN_2	20100419	Product data sheet	-	PMGD780SN_1		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts 	have been adapted to the	new company name whe	re appropriate.		
	 <u>Table 5 "Characteristics</u>": added V_{GS(th)} maximum value at condition T_j = 25 °C 					
	 <u>Section 10 "Legal information"</u>: updated 					
PMGD780SN_1	20040211	Product data	-	-		

Dual N-channel µTrenchMOS standard level FET

10. Legal information

10.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PMGD780SN_2
Product data sheet

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Dual N-channel µTrenchMOS standard level FET

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12. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Limiting values 2
5	Thermal characteristics 4
6	Characteristics 5
7	Package outline 9
8	Soldering 10
9	Revision history 11
10	Legal information 12
10.1	Data sheet status 12
10.2	Definitions 12
10.3	Disclaimers
10.4	Trademarks
11	Contact information 13
12	Contents 14

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